

REVISIONS

LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Updated drawing to the latest requirements of MIL-PRF-38534. -sld	16-01-21	Charles F. Saffle



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REV STATUS OF SHEETS	REV	A	A	A	A	A	A	A	A	A	A	A	A	A						
	SHEET	1	2	3	4	5	6	7	8	9	10	11								

PMIC N/A	PREPARED BY Greg Cecil	<p align="center">DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990 http://www.landandmaritime.dla.mil/</p>		
<p align="center">STANDARD MICROCIRCUIT DRAWING</p> <p align="center">THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE</p> <p align="center">AMSC N/A</p>	CHECKED BY Greg Cecil			
	APPROVED BY Charles F. Saffle	<p align="center">MICROCIRCUIT, HYBRID, 5 VOLT, SINGLE CHANNEL, DC/DC CONVERTER</p>		
	DRAWING APPROVAL DATE 10-04-21			
	REVISION LEVEL A	SIZE A	CAGE CODE 67268	5962-10219
	SHEET		1 OF 11	

1.3 Absolute maximum ratings. ^{1/}

Input voltage range	-0.5 V dc to +50 V dc
Lead temperature (soldering, 10 seconds)	+300°C
Storage temperature	-55°C to +125°C

1.4 Recommended operating conditions.

Input voltage range	+18 V dc to +40 V dc
Output power ^{2/ 3/}	≤ 50 W
Case operating temperature range (T _c) ^{4/}	-55°C to +125°C

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38534 - Hybrid Microcircuits, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.
 MIL-STD-1835 - Interface Standard for Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.
 MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at <http://quicksearch.dla.mil> or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item performance requirements for device classes D, E, G, H, and K shall be in accordance with MIL-PRF-38534. Compliance with MIL-PRF-38534 may include the performance of all tests herein or as designated in the device manufacturer's Quality Management (QM) plan or as designated for the applicable device class. Therefore, the tests and inspections herein may not be performed for the applicable device class (see MIL-PRF-38534). The manufacturer may eliminate, modify or optimize the tests and inspections herein, however the performance requirements as defined in MIL-PRF-38534 shall be met for the applicable device class. In addition, the modification in the QM plan shall not affect the form, fit, or function of the device for the applicable device class.

- ^{1/} Stresses above the absolute maximum ratings may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.
- ^{2/} Derate output power linearly above case temperature +125°C to 0 at +135°C.
- ^{3/} Limit represent 80 percent of total rated output current. To achieve rated output power, the remaining 20 percent of the total rated output current must be provided by the other output.
- ^{4/} For operation at temperatures between +85°C and +125°C, derate the maximum input voltage linearly from 60 V dc to 40 V dc and the maximum output power linearly from 100 percent to 75 percent.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-10219
		REVISION LEVEL A	SHEET 3

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38534 and herein.

3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.4 herein and figure 1.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 2.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full specified operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are defined in table I.

3.5 Marking of device(s). Marking of device(s) shall be in accordance with MIL-PRF-38534. The device shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's vendor similar PIN may also be marked.

3.6 Data. In addition to the general performance requirements of MIL-PRF-38534, the manufacturer of the device described herein shall maintain the electrical test data (variables format) from the initial quality conformance inspection group A lot sample, for each device type listed herein. Also, the data should include a summary of all parameters manually tested, and for those which, if any, are guaranteed. This data shall be maintained under document revision level control by the manufacturer and be made available to the preparing activity (DLA Land and Maritime -VA) upon request.

3.7 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to supply to this drawing. The certificate of compliance (original copy) submitted to DLA Land and Maritime -VA shall affirm that the manufacturer's product meets the performance requirements of MIL-PRF-38534 and herein.

3.8 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38534 shall be provided with each lot of microcircuits delivered to this drawing.

4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38534 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

4.2 Screening. Screening shall be in accordance with MIL-PRF-38534. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to either DLA Land and Maritime -VA or the acquiring activity upon request. Also, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.

(2) T_A as specified in accordance with table I of method 1015 of MIL-STD-883.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-10219
		REVISION LEVEL A	SHEET 4

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions 1/ -55°C ≤ T _C ≤ +85°C V _{IN} = 28 V dc ±5%, C _L = 0 unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Output voltage	V _{OUT}	I _{OUT} = 10 A	1	01	4.98	5.02	V
			2, 3		4.93	5.07	
Output current	I _{OUT}	V _{IN} = 18, 28, 40 V dc	1, 2, 3	01		10	A
Output ripple voltage 2/	V _{RIP}	I _{OUT} = 10 A.	1, 2, 3	01		30	mV p-p
Line regulation	V _{RLINE}	V _{IN} = 18, 28, 40 V dc, I _{OUT} = 0, 50%, 100% rated load	1, 2, 3	01	-10	+10	mV
Load regulation	V _{RLOAD}	V _{IN} = 18, 28, and 40 V dc, I _{OUT} = 0, 50%, and 100% rated load	1, 2, 3	01	-25	+25	mV
Input current	I _{IN}	I _{OUT} = 0, pin 3 open	1, 2, 3	01		200	mA
		Pin 3 shorted to Input return Pin 2	1, 2, 3	01		5.0	mA
Efficiency	E _{FF}	I _{OUT} = 10 A	1, 3	01	85	95	%
			2		83		
Isolation	ISO	Input to output or any pin to case (except pin 13) at 500 V dc	1	01	100		MΩ
Maximum capacitive load 3/ 4/	C _L	I _{OUT} = 10 A No effect on dc performance	1	01		5000	μF
Power dissipation load fault 5/	P _D	Short circuit	1, 2, 3	01		25	W
		Overload	1, 2, 3	01		25	
Current limit point 5/	I _{CL}	V _{OUT} = 90% of Nominal	1, 2, 3	01	10.5	13.5	%
Switching frequency	F _S	Sync input (pin 4) open I _{OUT} = 10 A	1, 2, 3	01	450	550	kHz
Sync frequency range, 6/	F _{SYNC}	External clock on Sync input pin 4. I _{OUT} = 10 A	1, 2, 3	01	450	600	kHz
Output response to step load changes 6/	V _{TLOAD}	50% to/from 100% load	4, 5, 6	01	-300	300	mV pk

See footnotes at end of table.

**STANDARD
MICROCIRCUIT DRAWING**

DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

REVISION LEVEL
A

5962-10219

SHEET
5

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions <u>1/</u> -55°C ≤ T _C ≤ +85°C V _{IN} = 28 V dc ±5%, C _L = 0 unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Recovery time, step load changes <u>6/ 7/</u>	TT _{LOAD}	50% to/from 100% load	4, 5, 6	01		250	μs
Output response to step line changes <u>3/ 8/</u>	VT _{LINE}	Input step, 24 V to/from 32 V I _{OUT} = 10 A	4, 5, 6	01	-50	50	mV pk
Recovery time step line changes <u>3/ 7/ 8/</u>	TT _{LINE}	Input step, 24 V to/from 32 V I _{OUT} = 10 A	4, 5, 6	01		200	μs
Turn on overshoot <u>9/</u>	VT _{ONOS}	0% load, 100% load Enable on.	4, 5, 6	01		250	%
Turn on delay <u>9/</u>	T _{OND}	0% load, 100% load. Enable on.	4, 5, 6	01	1.0	5.0	ms
Turn-Off Undershoot	V _{US}	100% load	4, 5, 6		0	100	mV

- 1/ For operation at temperatures between +85°C and +125°C derate the maximum input voltage linearly from 60 V dc to 40 V dc and the maximum output power linearly from 100 percent to 75 percent.
- 2/ Guaranteed for a dc to 20 MHz bandwidth. Tested using a 20 KHz to 10 MHz bandwidth.
- 3/ Parameter is tested as part of design characterization or after design changes. Thereafter, parameter shall be guaranteed to the limits specified.
- 4/ Capacitive load may be any value from 0 to the maximum limit without compromising dc performance. A capacitive load in excess of the maximum limit may interfere with the proper operation of the converter's overload protection, causing erratic behavior during turn-on.
- 5/ Overload power dissipation is defined as the device power dissipation with the load set such that V_{OUT} = 90 percent of nominal.
- 6/ Load step slew rate ≤ 0.5 A/μS.
- 7/ Recovery time is measured from the initiation of the transient to where V_{OUT} has returned to within ±1 percent of its steady state value.
- 8/ Line step slew rate ≤ 1 V/μS.
- 9/ Turn-on delay time is measured from either a step application of input power or a logic low to a logic high transition on the inhibit pin (pin 3) to the point where V_{OUT} = 90 percent of nominal.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-10219
		REVISION LEVEL A	SHEET 6

Case outline X.

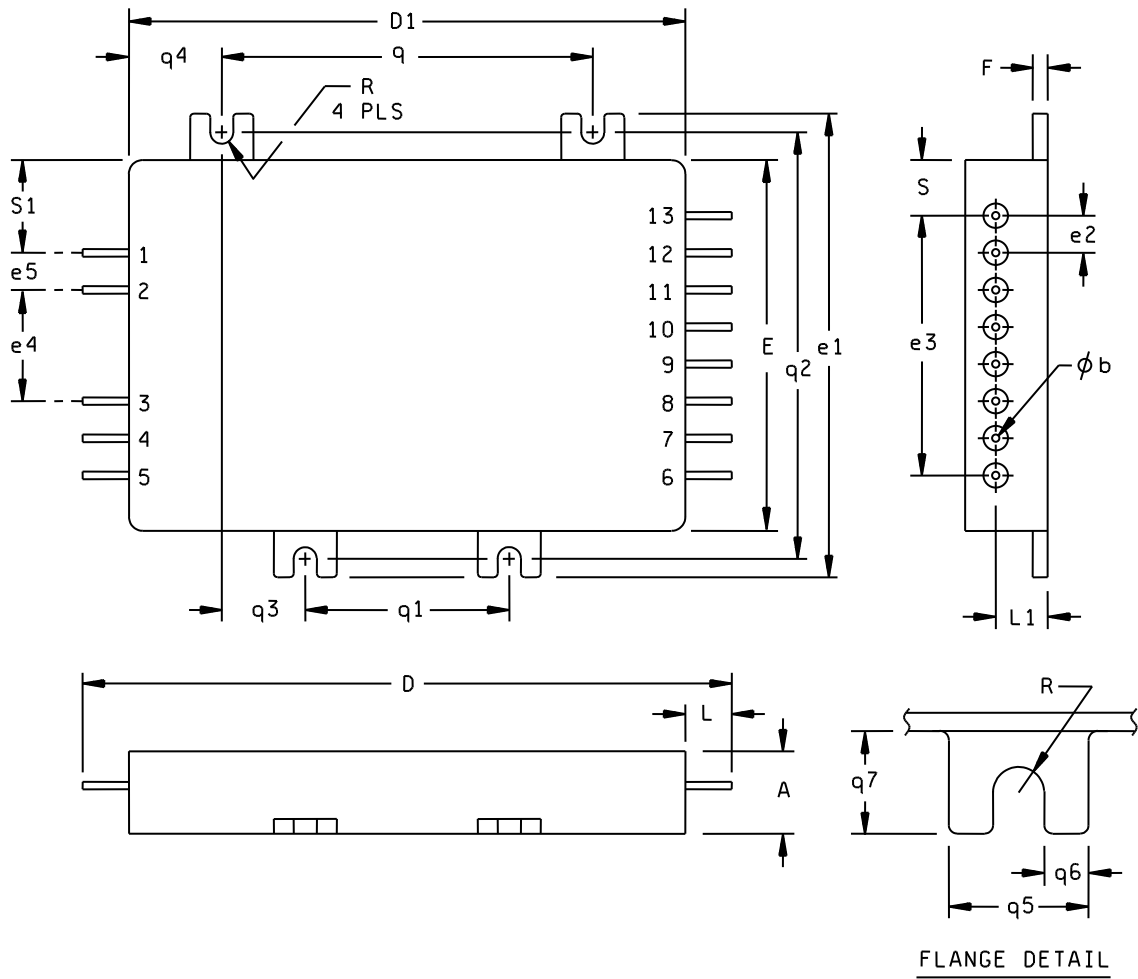


FIGURE 1. Case outline.

**STANDARD
MICROCIRCUIT DRAWING**

DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

5962-10219

REVISION LEVEL
A

SHEET
7

Case outline X - Continued.

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A		12.07		.475
D	88.90 REF		3.50 REF	
D1		77.85		3.065
E		52.20		2.055
e1	63.37	63.63	2.495	2.505
e2/e5	4.95	5.21	.195	.205
e3	35.56 REF		1.400 REF	
e4	15.11	15.37	.595	.605
F		2.03		.080
L/q7	6.10	6.60	.240	.260
L1	6.48	6.73	.255	.265
q	50.55	55.05	1.990	2.010
q1	27.69	28.19	1.090	1.110
q2	58.17	58.67	2.290	2.310
q3	11.18	11.67	.440	.460
q4	12.57	12.83	.495	.505
q5	9.91	10.41	.390	.410
q6	3.30	3.81	.130	.150
R		1.588		.625
S	7.37	7.87	.290	.310
S1	12.45	12.95	.490	.510
∅b	.89	1.14	.035	.045

NOTES:

1. The U.S. government preferred system of measurement is the metric SI. This item was designed using inch-pound units of measurement. In case of problems involving conflicts between the metric and inch-pound units, the inch-pound units shall rule.
2. Lead identification for reference only.
3. Case outline weight: 110 grams maximum.

FIGURE 1. Case outline - Continued.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-10219
		REVISION LEVEL A	SHEET 8

Device type	01
Case outline	X
Terminal number	Terminal symbol
1	+ Input Voltage
2	Input return
3	Inhibit
4	Sync input
5	Sync output
6	+ Sense
7	+ Output Voltage
8	+ Output Voltage
9	Output Return
10	Output Return
11	- Sense
12	Output Adjust
13	Case Ground

FIGURE 2. Terminal connections.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-10219
		REVISION LEVEL A	SHEET 9

TABLE II. Electrical test requirements.

MIL-PRF-38534 test requirements	Subgroups (in accordance with MIL-PRF-38534, group A test table)
Interim electrical parameters	---
Final electrical parameters	1*, 2, 3, 4, 5, 6
Group A test requirements	1, 2, 3, 4, 5, 6
Group C end-point electrical parameters	1, 2, 3, 4
End-point electrical parameters for radiation hardness assurance (RHA) devices	Not applicable

* PDA applies to subgroup 1.

4.3 Conformance and periodic inspections. Conformance inspection (CI) and periodic inspection (PI) shall be in accordance with MIL-PRF-38534 and as specified herein.

4.3.1 Group A inspection (CI). Group A inspection shall be in accordance with MIL-PRF-38534 and as follows:

- a. Tests shall be as specified in table II herein.
- b. Subgroups 7, 8, 9, 10, and 11 shall be omitted.

4.3.2 Group B inspection (PI). Group B inspection shall be in accordance with MIL-PRF-38534.

4.3.3 Group C inspection (PI). Group C inspection shall be in accordance with MIL-PRF-38534 and as follows:

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to either DLA Land and Maritime -VA or the acquiring activity upon request. Also, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
 - (2) T_A as specified in accordance with table I of method 1005 of MIL-STD-883.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

4.3.4 Group D inspection (PI). Group D inspection shall be in accordance with MIL-PRF-38534.

4.3.5 Radiation Hardness Assurance (RHA) inspection. RHA inspection is not currently applicable to this drawing.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-10219
		REVISION LEVEL A	SHEET 10

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38534.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated as specified in MIL-PRF-38534.

6.4 Record of users. Military and industrial users should inform DLA Land and Maritime when a system application requires configuration control and the applicable SMD to that system. DLA Land and Maritime will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DLA Land and Maritime-VA, telephone (614) 692-8108.

6.5 Comments. Comments on this drawing should be directed to DLA Land and Maritime-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-1081.

6.6 Sources of supply. Sources of supply are listed in MIL-HDBK-103 and QML-38534. The vendors, listed in MIL-HDBK-103 and QML-38534, have submitted a certificate of compliance (see 3.7 herein) to DLA Land and Maritime-VA and have agreed to this drawing.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-10219
		REVISION LEVEL A	SHEET 11

STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 16-01-21

Approved sources of supply for SMD 5962-10219 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38534 during the next revisions. MIL-HDBK-103 and QML-38534 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DLA Land and Maritime -VA. This information bulletin is superseded by the next dated revisions of MIL-HDBK-103 and QML-38534. DLA Land and Maritime maintains an online database of all current sources of supply at <http://www.landandmaritime.dla.mil/Programs/Smcr/>.

Standard microcircuit drawing PIN <u>1/</u>	Vendor CAGE number	Vendor similar PIN <u>2/</u>
5962-1021901KXA 5962-1021901KXC	52467 52467	GH2805S/CK GH2805S/CK

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the Vendor to determine its availability.
- 2/ **Caution.** Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number

52467

Vendor name and address

International Rectifier Corporation
2520 Junction Ave
San Jose, CA 95134

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